#### **Truth Table**

Pin	State						
	0	1					
5	Auto Reset Operating	Auto Reset Disabled					
6	Timer Operational	Master Reset On					
9	Output Initially Low	Output Initially High					
	after Reset	after Reset					
10	Single Cycle Mode	Recycle Mode					

#### **Division Ratio Table**

		Number of	Count
Α	В	Counter Stages	2 <sup>n</sup>
		n	
0	0	13	8192
0	1	10	1024
1	0	8	256
1	1	16	65536

### **Operating Characteristics**

With Auto Reset pin set to a "0" the counter circuit is initialized by turning on power. Or with power already on, the counter circuit is reset when the Master Reset pin is set to a "1". Both types of reset will result in synchronously resetting all counter stages independent of counter state.

The RC oscillator frequency is determined by the external RC network, i.e.:

$$f = \frac{1}{2.3 \ R_{tc} C_{tc}} \text{if (1 kHz} \leq f \leq 100 \ \text{kHz)}$$

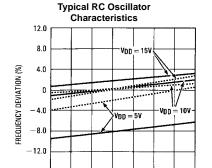
and  $R_S\approx 2~R_{tc}$  where  $R_S\geq 10~k\Omega$ 

The time select inputs (A and B) provide a two-bit address to output any one of four counter stages  $(2^8, 2^{10}, 2^{13}, \text{ and } 2^{16})$ . The  $2^n$  counts as shown in the Division Ratio Table represent the Q output of the Nth stage of the counter. When A is "1",  $2^{16}$  is selected for both states of B.

However, when B is "0", normal counting is interrupted and the 9th counter stage receives its clock directly from the oscillator (i.e., effectively outputting 2<sup>8</sup>).

The  $Q/\overline{Q}$  select output control pin provides for a choice of output level. When the counter is in a reset condition and  $Q/\overline{Q}$  select pin is set to a "0" the Q output is a "0". Correspondingly, when  $Q/\overline{Q}$  select pin is set to a "1" the Q output is a "1".

When the mode control pin is set to a "1", the selected count is continually transmitted to the output. But, with mode pin "0" and after a reset condition the RS flip-flop resets (see Logic Diagram), counting commences and after  $2^{n-1}$  counts the RS flip-flop sets which causes the output to change state. Hence, after another  $2^{n-1}$  counts the output will not change. Thus, a Master Reset pulse must be applied or a change in the mode pin level is required to reset the single cycle operation.

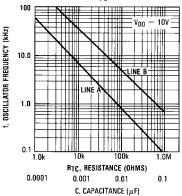


#### TA, AMBIENT TEMPERATURE (°C)

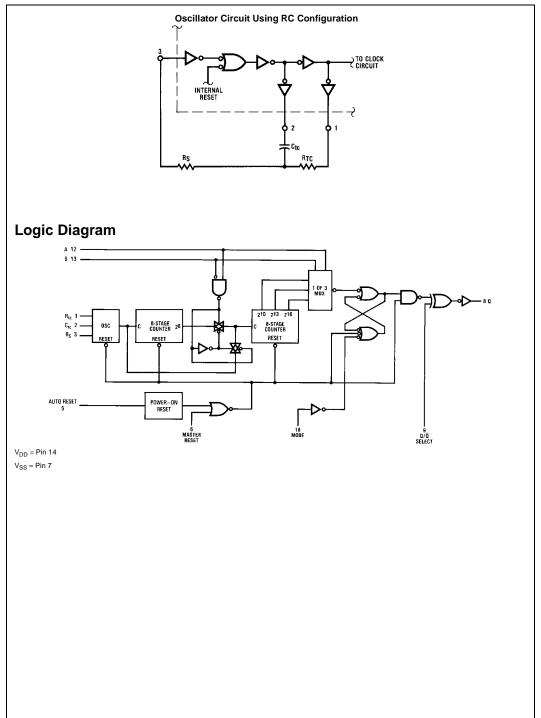
Solid Line =  $R_{TC}$  = 56 k $\Omega$ ,  $R_S$  = 1 k $\Omega$  and C = 1000 pF f = 10.2 kHz @  $V_{DD}$  = 10V and  $T_A$  = 25° Dashed Line =  $R_{TC}$  = 56 k $\Omega$ ,  $R_S$  = 120 k $\Omega$  and C = 1000 pF f = 7.75 kHz @  $V_{DD}$  = 10V and  $T_A$  = 25°

-55 - 25

# RC Oscillator Frequency as a Function of $R_{TC}$ and $\mbox{\bf C}$



Line A: f as a function of C and (R<sub>TC</sub> = 56 k $\Omega$ ; R<sub>S</sub> = 120k Line B: f as a function of R<sub>TC</sub> and (C = 100 pF; R<sub>S</sub> = 2 R<sub>TC</sub>



### **Absolute Maximum Ratings**(Note 1)

(Note 2)

**Recommended Operating** Conditions (Note 2)

Supply Voltage  $(V_{DD})$ 

Supply Voltage ( $V_{DD}$ ) -0.5V to +18VInput Voltage (V<sub>IN</sub>) -0.5V to  $V_{DD}$  +0.5VStorage Temperature Range  $(T_S)$ -65°C to +150°C

Input Voltage (V<sub>IN</sub>) Operating Temperature Range 3V to 15V 0 to  $V_{\text{DD}}$ 

Power Dissipation (P<sub>D</sub>) Dual-In-Line

700 mW

-40°C to +85°C

Lead Temperature (T<sub>L</sub>)

Small Outline

500 mW

260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides

conditions for actual device operation.

(soldering, 10 seconds)

Note 2:  $V_{SS} = 0V$  unless otherwise specified.

## DC Electrical Characteristics (Note 2)

Symbol	Parameter	Conditions	-40°C		+25°C			+85°C		Units
Syllibol		Conditions	Min	Max	Min	Тур	Max	Min	Max	Ullits
I <sub>DD</sub>	Quiescent Device Current	$V_{DD} = 5V$ , $V_{IN} = V_{DD}$ or $V_{SS}$		20		0.005	20		150	μА
		$V_{DD} = 10V$ , $V_{IN} = V_{DD}$ or $V_{SS}$		40		0.010	40		300	μΑ
		$V_{DD} = 15V$ , $V_{IN} = V_{DD}$ or $V_{SS}$		80		0.015	80		600	μΑ
V <sub>OL</sub>	LOW Level Output Voltage	V <sub>DD</sub> = 5V		0.05		0	0.05		0.05	V
		$V_{DD} = 10V   I_O  < 1 \mu A$		0.05		0	0.05		0.05	V
		V <sub>DD</sub> = 15V		0.05		0	0.05		0.05	V
V <sub>OH</sub>	HIGH Level Output Voltage	V <sub>DD</sub> = 5V	4.95		4.95	5		4.95		V
		$V_{DD} = 10V   I_O  < 1 \mu A$	9.95		9.95	10		9.95		V
		V <sub>DD</sub> = 15V	14.95		14.95	15		14.95		V
V <sub>IL</sub>	LOW Level Input Voltage	$V_{DD} = 5V$ , $V_{O} = 0.5V$ or 4.5V		1.5		2	1.5		1.5	V
		$V_{DD} = 10V, V_{O} = 1.0V \text{ or } 9.0V$		3.0		4	3.0		3.0	V
		$V_{DD} = 15V, V_{O} = 1.5V \text{ or } 13.5V$		4.0		6	4.0		4.0	V
V <sub>IH</sub>	HIGH Level Input Voltage	V <sub>DD</sub> = 5V, V <sub>O</sub> = 0.5V or 4.5V	3.5		3.5	3		3.5		V
		$V_{DD} = 10V, V_{O} = 1.0V \text{ or } 9.0V$	7.0		7.0	6		7.0		V
		$V_{DD} = 15V, V_{O} = 1.5V \text{ or } 13.5V$	11.0		11.0	9		11.0		V
I <sub>OL</sub>	LOW Level Output Current	$V_{DD} = 5V, V_{O} = 0.4V$	2.32		1.96	3.6		1.6		mA
	(Note 3)	$V_{DD} = 10V, V_{O} = 0.5V$	3.18		2.66	9.0		2.18		mA
		$V_{DD} = 15V, V_{O} = 1.5V$	12.4		10.4	34.0		8.50		mA
I <sub>OH</sub>	HIGH Level Output Current	$V_{DD} = 5V, V_{O} = 2.5V$	5.1		4.27	130		3.5		mA
	(Note 3)	$V_{DD} = 10V, V_{O} = 9.5V$	2.69		2.25	8.0		1.85		mA
		$V_{DD} = 15V, V_{O} = 13.5V$	10.5		8.8	30.0		7.22		mA
I <sub>IN</sub>	Input Current	V <sub>DD</sub> = 15V, V <sub>IN</sub> = 0V		-0.3		-10 <sup>-5</sup>	-0.3		-1.0	μА
		$V_{DD} = 15V, V_{IN} = 15V$		0.3		10 <sup>-5</sup>	0.3		1.0	μΑ

Note 3: I<sub>OH</sub> and I<sub>OL</sub> are tested one output at a time.

## AC Electrical Characteristics (Note 4)

 $T_A = 25^{\circ}C$ ,  $C_L = 50$  pF (refer to test circuits)

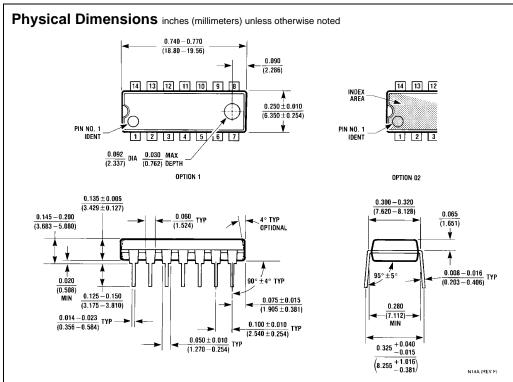
Symbol	Parameter	Conditions	Min	Тур	Max	Units
t <sub>TLH</sub>	Output Rise Time	$V_{DD} = 5V$		50	200	ns
		V <sub>DD</sub> = 10V		30	100	ns
		V <sub>DD</sub> = 15V		25	80	ns
t <sub>THL</sub>	Output Fall Time	$V_{DD} = 5V$		50	200	ns
		V <sub>DD</sub> = 10V		30	100	ns
		V <sub>DD</sub> = 15V		25	80	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Turn-Off, Turn-On Propagation Delay,	$V_{DD} = 5V$		1.8	4.0	μs
	Clock to Q (28 Output)	$V_{DD} = 10V$		0.6	1.5	μs
		V <sub>DD</sub> = 15V		0.4	1.0	μs
t <sub>PHL</sub> , t <sub>PLH</sub>	Turn-On, Turn-Off Propagation Delay,	$V_{DD} = 5V$		3.2	8.0	μs
	Clock to Q (2 <sup>16</sup> Output)	$V_{DD} = 10V$		1.5	3.0	μs
		$V_{DD} = 15V$		1.0	2.0	μs
t <sub>WH(CL)</sub>	Clock Pulse Width	$V_{DD} = 5V$	400	200		ns
		$V_{DD} = 10V$	200	100		ns
		$V_{DD} = 15V$	150	70		ns
$f_{CL}$	Clock Pulse Frequency	$V_{DD} = 5V$		2.5	1.0	MHz
		$V_{DD} = 10V$		6.0	3.0	MHz
		$V_{DD} = 15V$		8.5	4.0	MHz
t <sub>WH(R)</sub>	MR Pulse Width	$V_{DD} = 5V$	400	170		ns
		$V_{DD} = 10V$	200	75		ns
		V <sub>DD</sub> = 15V	150	50		ns
C <sub>I</sub>	Average Input Capacitance	Any Input		5.0	7.5	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 5)			100		pF

Note 4: AC Parameters are guaranteed by DC correlated testing.

Note 5: C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation, see Family Characteristics application note: AN-90.

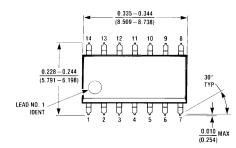
## **Test Circuits and Waveforms** Power Dissipation Test Circuit and Waveforms Switching Time Test Circuit and Waveforms PULSE Generator AR Q/Q SELECT Q/Q SELECT MODE MODE -∳vss (R $_{tc}$ and C $_{tc}$ outputs are left open) — tWH(CL) --- tWH(CL) -**←**20 ns -20 ns 90% 50% / - 50% 50% DUTY CYCLE

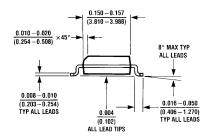
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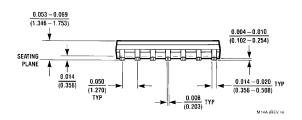


14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

#### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)







14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A

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